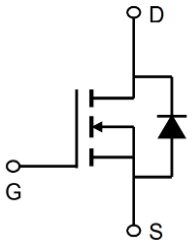
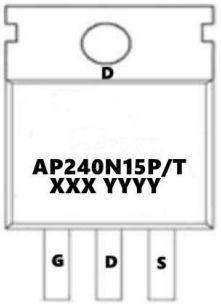
AP240N15P/T

150V N-Channel Enhancement Mode MOSFET

Description

The AP240N15P/T uses advanced SGT technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a Battery protection or in other Switching application.





General Features

V_{DS} = 150V I_D =240A

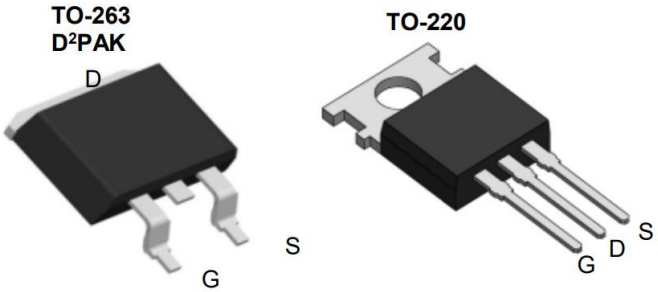
$R_{DS(ON)}$ < 5.8mΩ @ V_{GS}=10V **(Type：4.8mΩ)**

Application

DC/DC Converter

LED Backlighting

Power Management Switches



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP240N15P	TO-220-3L	AP240N15P XXX YYYY	1000
AP240N15T	TO-263-3L	AP240N15T XXX YYYY	800

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	150	V
VGS	Gate-Source Voltage	±20	V
I_D@T_C=25℃	Continuous Drain Current, V_{GS} @ 10V	240	A
I_D@T_C=100℃	Continuous Drain Current, V_{GS} @ 10V	185	A
IDM	Pulsed Drain Current	720	A
EAS	Single Pulse Avalanche Energy	1764	mJ
IAS	Avalanche Current	64	A
P_D@T_C=25℃	Total Power Dissipation[4]	326	W
TSTG	Storage Temperature Range	-55 to 150	℃
T_J	Operating Junction Temperature Range	-55 to 150	℃
RθJA	Thermal Resistance Junction-Ambient	0.46	℃/W
RθJC	Thermal Resistance Junction-Case	62	℃/W

Electrical Characteristics (T_C=25℃unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	150	165		V
IDSS	Zero Gate Voltage Drain Current	V_{DS}=140V, V_{GS}=0V			1	μA
IGSS	Gate-Body Leakage Current	V_{GS}=±20V, V_{DS}=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS, ID=250μA	2.0	2.9	4.0	V
GFS	Forward Transconductance	V_{DS}=5V, I_D=15A		33		S
RDS(ON)	Drain-Source On-State Resistance	V_{GS}=10V, I_D=40A		4.8	5.8	mΩ
Ciss	Input Capacitance	V_{DS}=25V,V_{GS}=0V, f=1.0MHz		4200		pF
Coss	Output Capacitance			2867		pF
Crss	Reverse Transfer Capacitance			215		pF
td(on)	Turn-on Delay Time	V_{GS}=10V, V_{DS}=75V, RL=1.07Ω, RGEN=3Ω		18		nS
tr	Turn-on Rise Time			22		nS
td(off)	Turn-Off Delay Time			35		nS
t_f	Turn-Off Fall Time			10		nS
Q_g	Total Gate Charge	V_{GS}=10V, V_{DS}=75V, I_D=70A		65		nC
Qgs	Gate-Source Charge			20		nC
Qgd	Gate-Drain Charge			19		nC
ISD	Source-Drain Current (Body Diode)				240	A
VSD	Forward on Voltage (Note 3)	V_{GS}=0V, I_S=20A			1.2	V
trr	Reverse Recovery Time	I_F=20A, dI/dt=500A/us		101		ns
Qrr	Reverse Recovery Charge	I_F=20A, dI/dt=500A/us		1,240		nC

Notes:

1、The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.

2、The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%

3、The EAS data shows Max. rating . The test condition is V_{DD}=50V, V_{GS}=10V, L=0.5mH, I_{AS}=64A

4、The power dissipation is limited by 150°C junction temperature

5、The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

Typical Characteristics

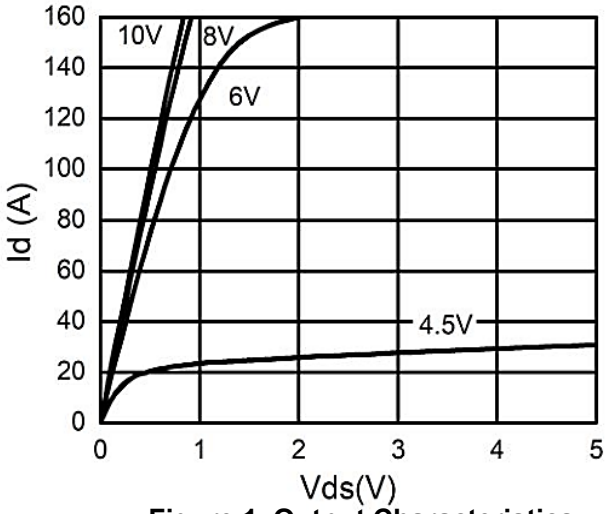


Figure 1. Output Characteristics

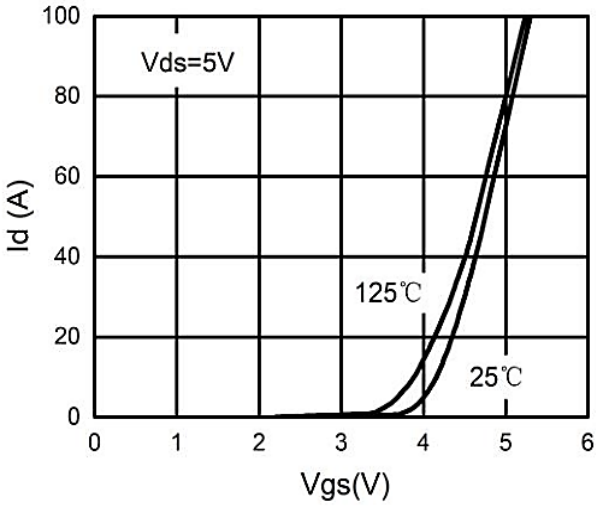


Figure 2. Transfer Characteristics

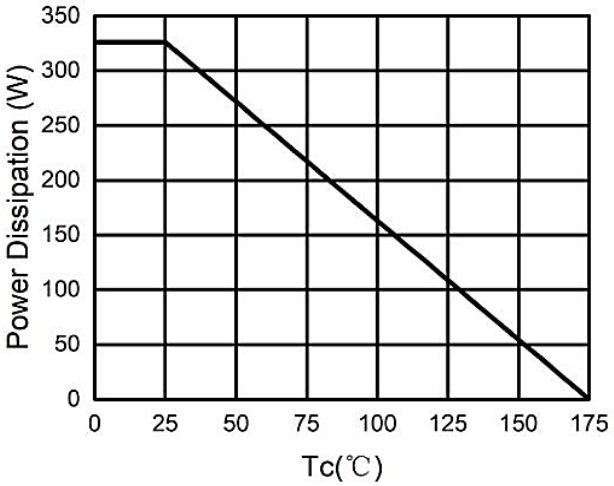


Figure 3. Power Dissipation

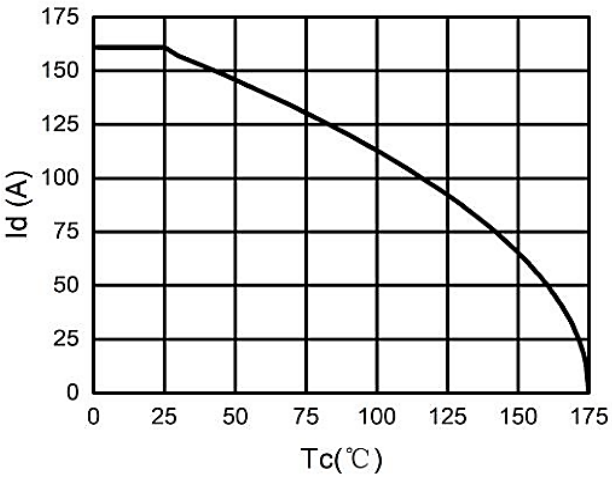


Figure 4. Drain Current

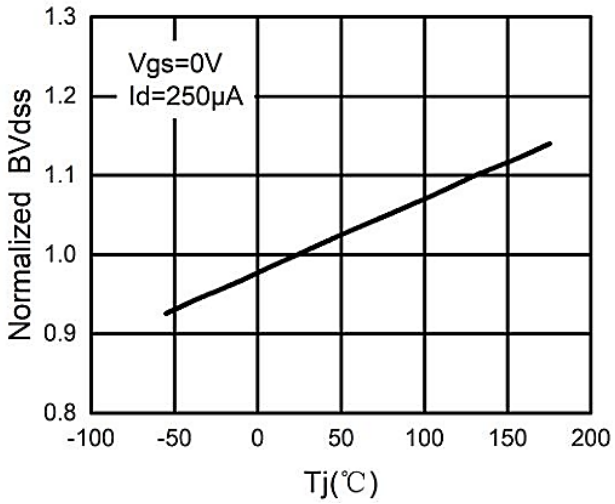


Figure5. BVDSS vs Junction Temperature

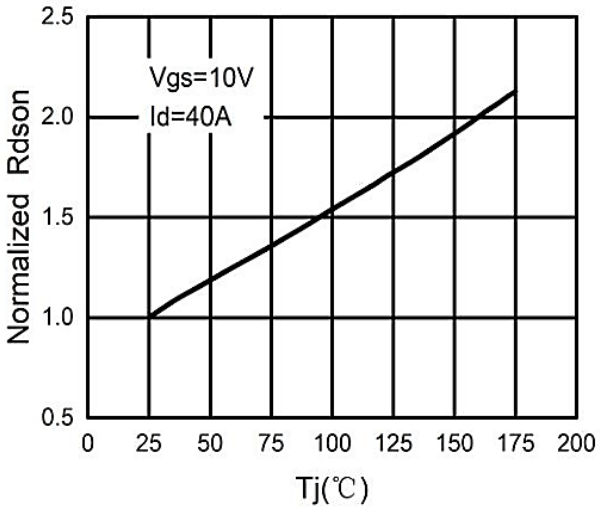


Figure6. RDS(ON) vs Junction Temperature

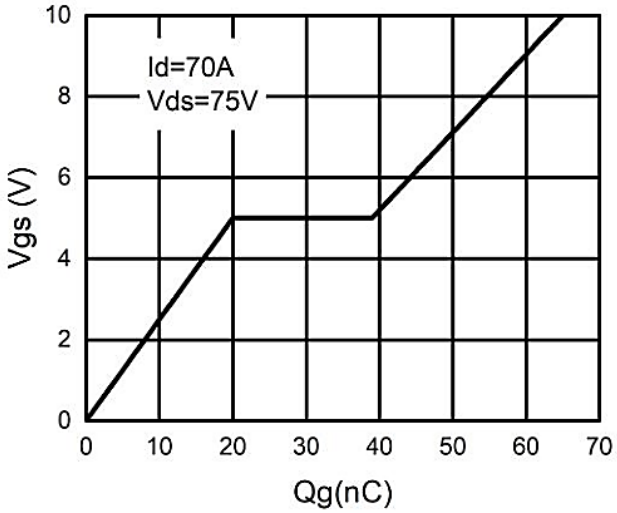


Figure 7. Gate Charge Waveforms

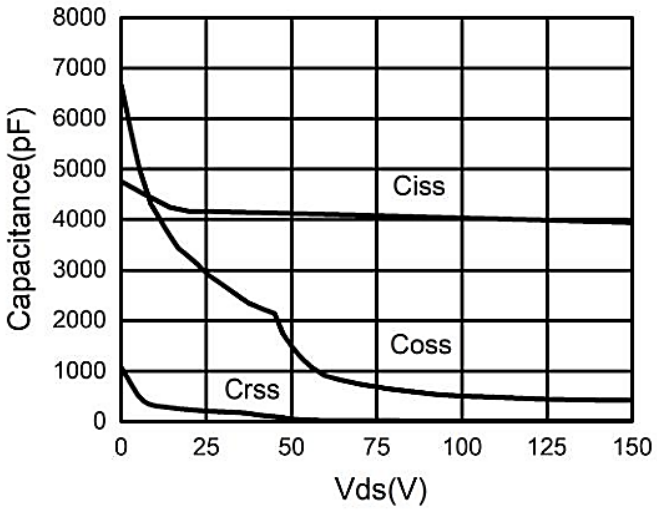


Figure 8. Capacitance

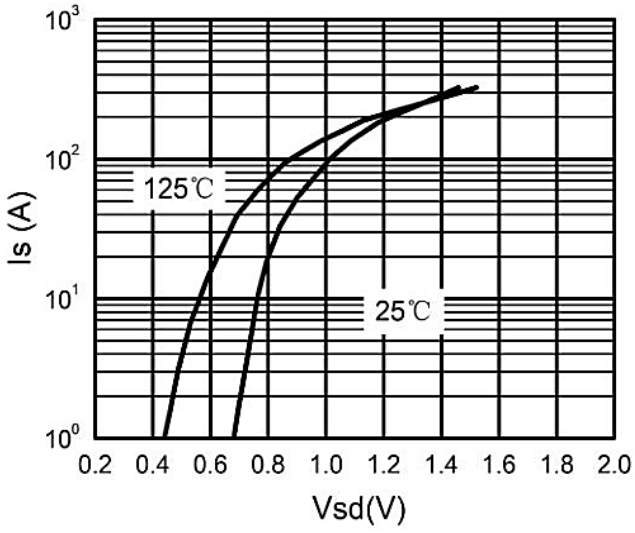


Figure 9. Body-Diode Characteristics

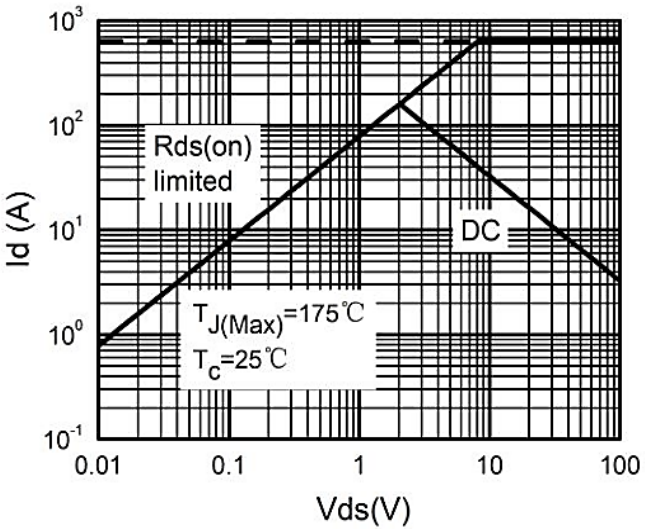


Figure 10. Maximum Safe Operating Area

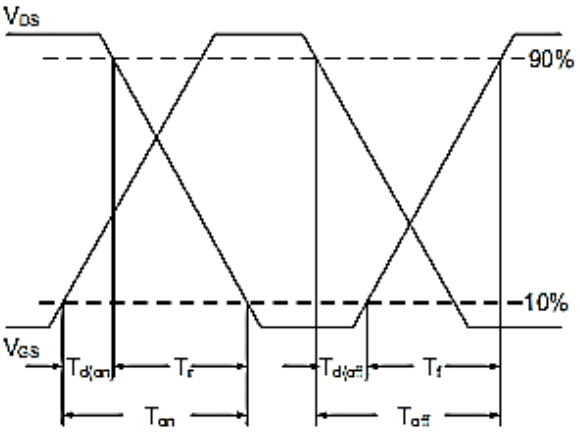


Figure11.Switching Time Waveform

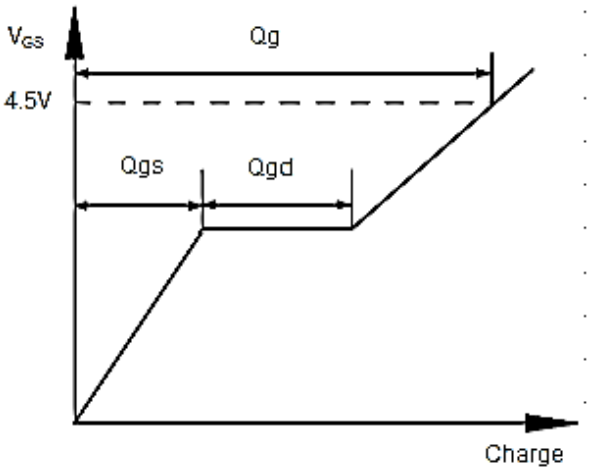
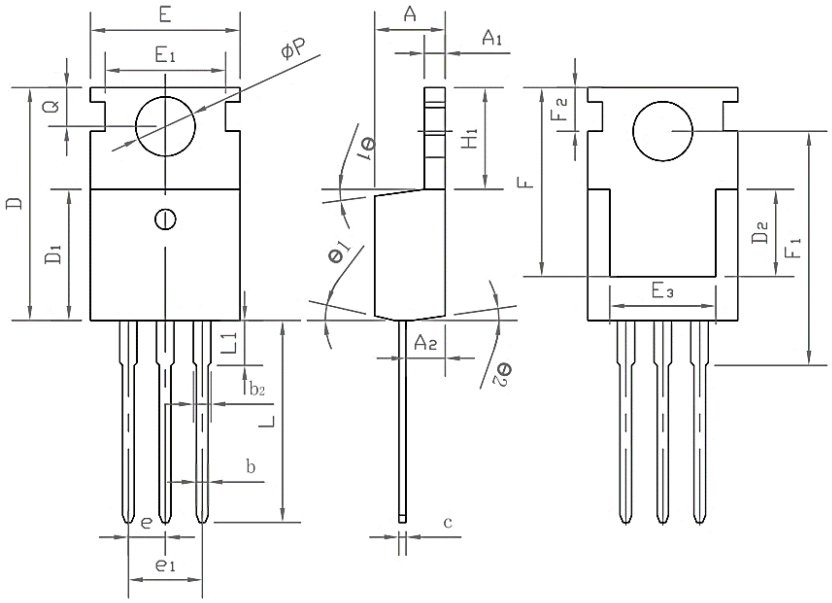


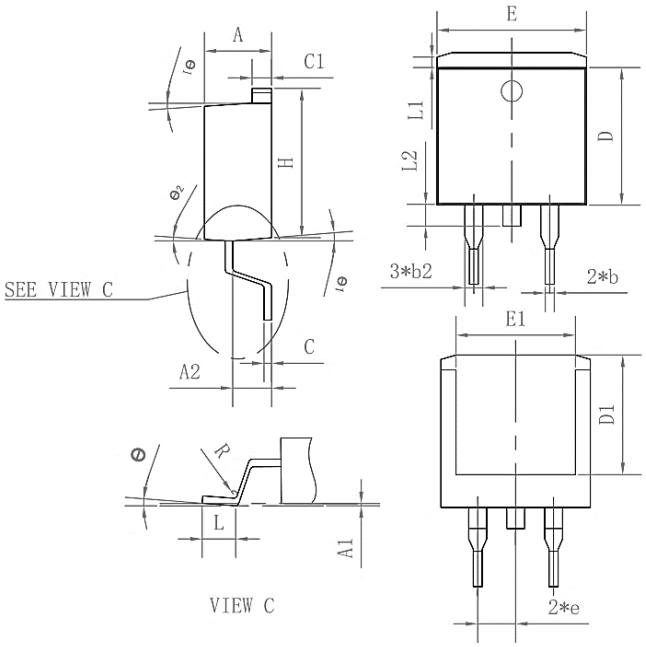
Figure12.Gate Charge Waveform

Package Mechanical Data-TO-220-3L-SLK



Symbol	Common		
	mm		
	Mim	Nom	Max
A	4.27	4.57	4.87
A1	1.15	1.30	1.45
A2	2.10	2.40	2.70
b	0.70	0.80	1.00
b2	1.17	1.27	1.50
D	0.40	0.50	0.65
D1	8.80	9.10	9.40
D2	5.70	6.70	7.00
E	9.70	10.00	10.30
E1	-	8.70	-
E2	9.63	10.00	10.35
E3	7.00	8.00	8.40
e	0.37		
e1	0.10		
H1	6.00	6.50	6.85
L	12.75	13.50	13.90
L1	-	3.10	3.40
Φp	3.45	3.60	3.75
Q	2.60	2.80	3.00
θ1	4°	7°	10°
θ2	0°	3°	6°
F	13.30	13.50	13.70
F1	15.50	15.90	16.30
F2	2.80	3.00	3.20

Package Mechanical Data-TO-263-3L-SLK



Symbol	Common		
	mm		
	Mim	Nom	Max
A	4.35	4.47	4.60
A1	0.09	0.10	0.11
A2	2.30	2.40	2.70
b	0.70	0.80	1.00
b2	1.25	1.36	1.50
C	0.45	0.50	0.65
C1	1.29	1.30	9.40
D	9.10	9.20	9.30
D1	7.90	8.00	8.10
E	9.85	10.00	10.20
E1	7.90	8.00	8.10
H	15.30	15.50	15.70
e	-	2.54	-
L	2.34	2.54	2.74
L1	1.00	1.10	1.20
L2	1.30	1.40	1.50
R	0.24	0.25	0.26
θ	0°	4°	8°
Θ1	4°	7°	10°
Θ2	0°	3°	6°